



SPP8805

P-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPP8805 is the Dual P-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

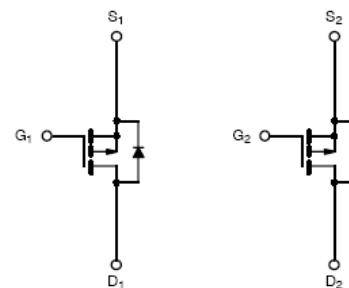
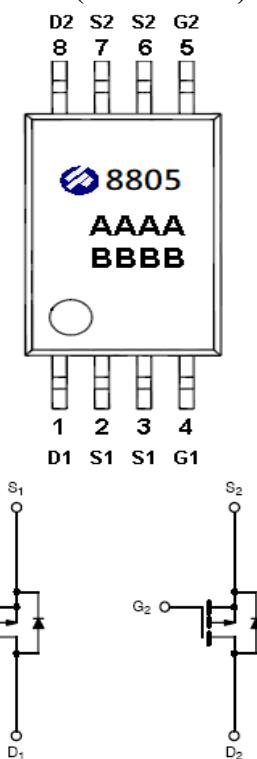
FEATURES

- ◆ -20V/-7.2A,R_{DS(ON)}=40mΩ@V_{GS}=-4.5V
- ◆ -20V/-5.2A,R_{DS(ON)}=52mΩ@V_{GS}=-2.5V
- ◆ -20V/-3.6A,R_{DS(ON)}=70mΩ@V_{GS}=-1.8V
- ◆ Super high density cell design for extremely low R_{DS}(ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TSSOP-8P package design

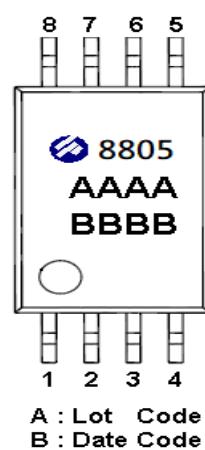
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(TSSOP – 8P)



PART MARKING





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PIN DESCRIPTION

Pin	Symbol	Description
1	D1	Drain
2	S1	Source
3	S1	Source
4	G1	Gate
5	G2	Gate
6	S2	Source
7	S2	Source
8	D2	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP8805TS8RGB	TSSOP- 8P	8805

※ SPP8805TS8RGB : 13" Tape Reel ; Pb – Free; Halogen -Free

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-20	V
Gate –Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150°C)	TA=25°C	ID	-7.6
	TA=70°C		-5.4
Pulsed Drain Current	I _{DM}	-30	A
Continuous Source Current(Diode Conduction)	I _S	-2.3	A
Power Dissipation	TA=25°C	P _D	2.8
	TA=70°C		1.8
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	70	°C/W



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ELECTRICAL CHARACTERISTICS

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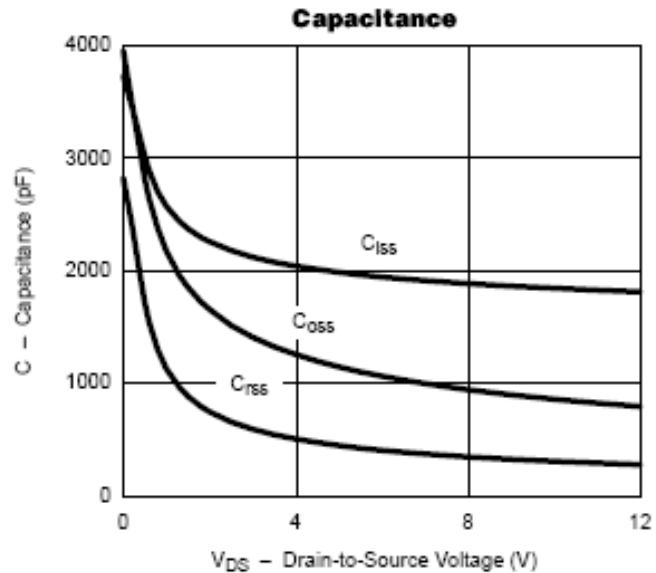
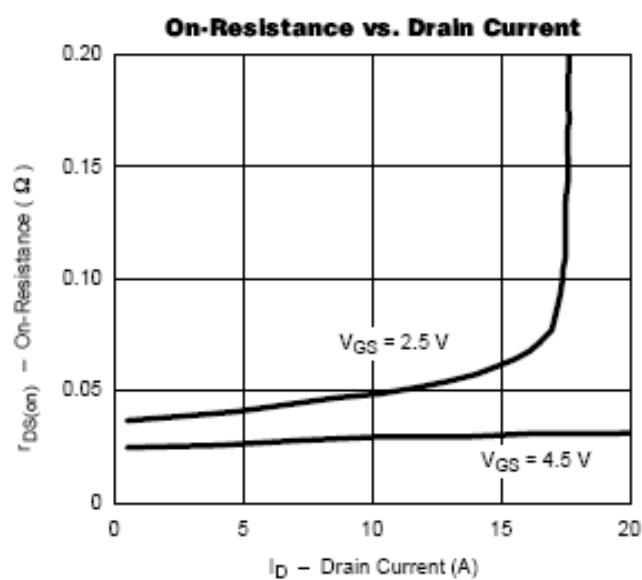
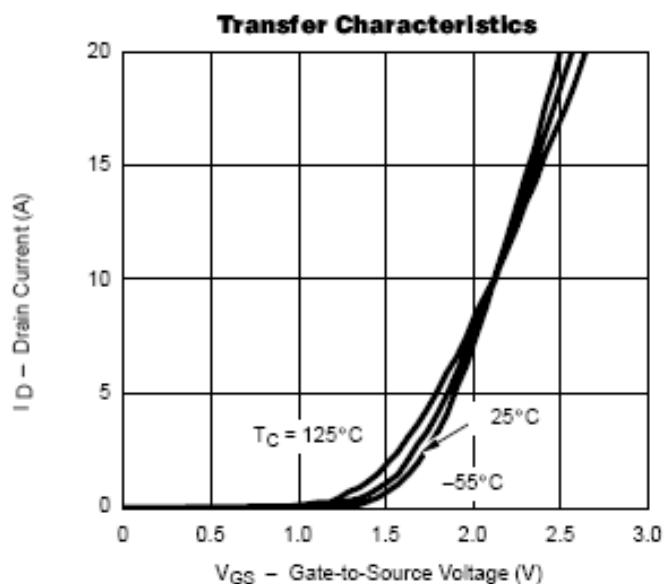
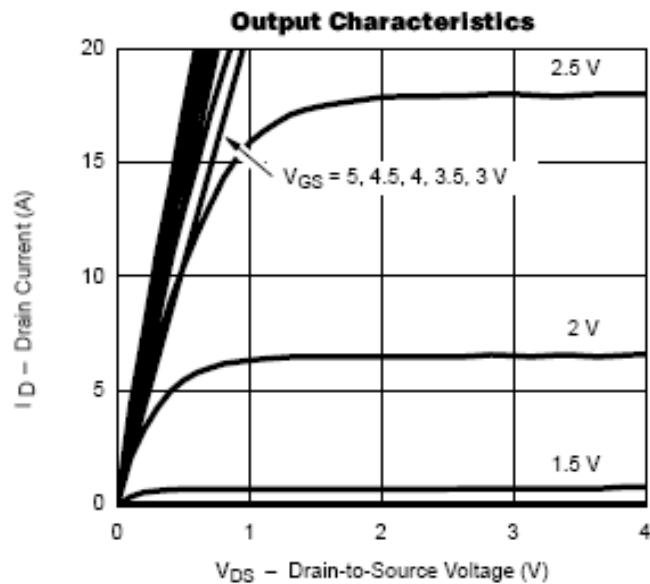
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, ID=-250uA	-20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , ID=-250uA	-0.35		-0.9	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-16V, V _{GS} =0V			-1	uA
		V _{DS} =-16V, V _{GS} =0V T _J =55°C			-10	
On-State Drain Current	I _{D(on)}	V _{DS} ≤-5V, V _{GS} =-4.5V	-10			A
Drain-Source On-Resistance	R _{DSS(on)}	V _{GS} =-4.5V, ID=-7.2A		0.030	0.040	Ω
		V _{GS} =-2.5V, ID=-5.2A		0.040	0.052	
		V _{GS} =-1.8V, ID=-3.6A		0.055	0.070	
Forward Transconductance	g _{fs}	V _{DS} =-5.0V, ID=-6.2A		14		S
Diode Forward Voltage	V _{SD}	I _S =-2.5A, V _{GS} =0V		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =-10V, V _{GS} =-4.5V ID=-6.4A		20	25	nC
Gate-Source Charge	Q _{gs}			4.5		
Gate-Drain Charge	Q _{gd}			8.0		
Input Capacitance	C _{iss}	V _{DS} =-10V, V _{GS} =0V f=1MHz		700		pF
Output Capacitance	C _{oss}			160		
Reverse Transfer Capacitance	C _{rss}			120		
Turn-On Time	t _{d(on)}	V _{DD} =-10V, R _L =6Ω ID=-1.0A, V _{GEN} =-4.5V R _G =6Ω		20	30	ns
	t _r			40	65	
Turn-Off Time	t _{d(off)}			90	120	
	t _f			70	90	



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TYPICAL CHARACTERISTICS

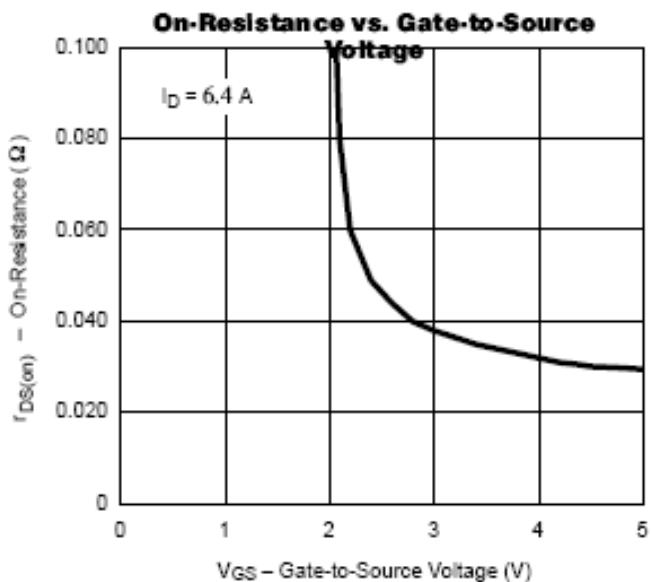
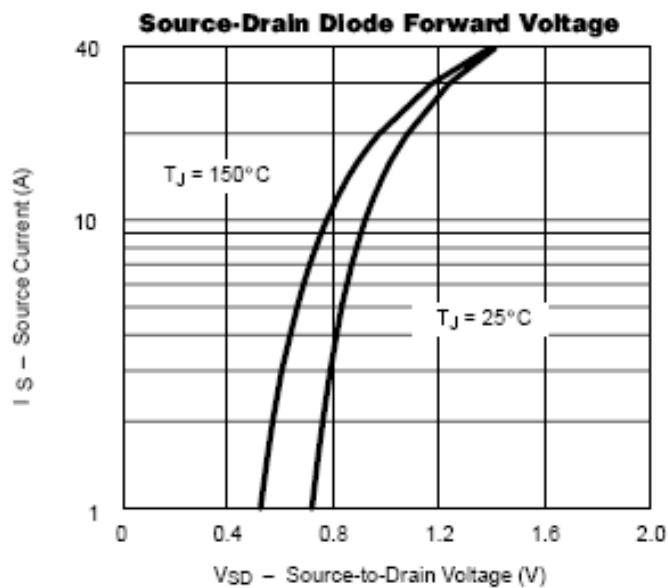
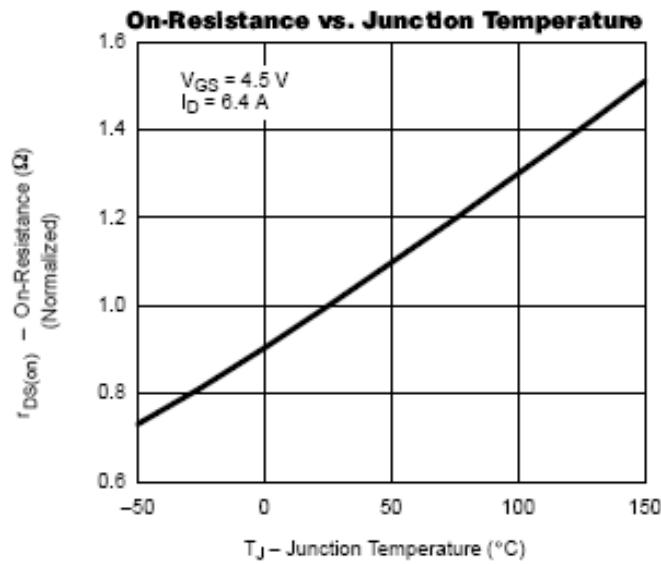
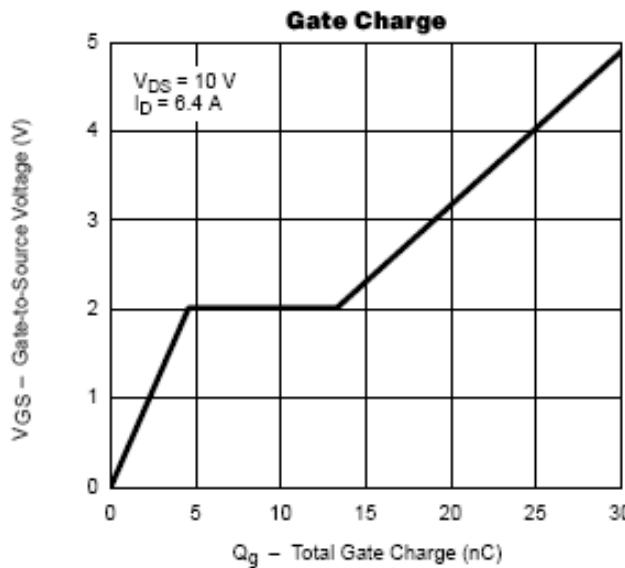




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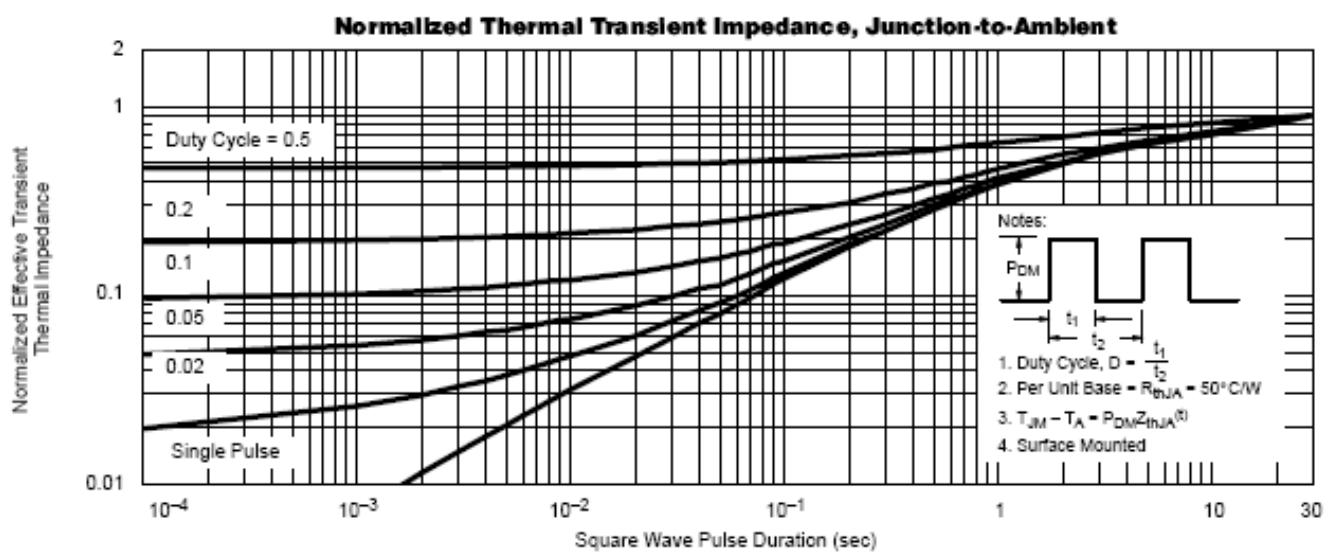
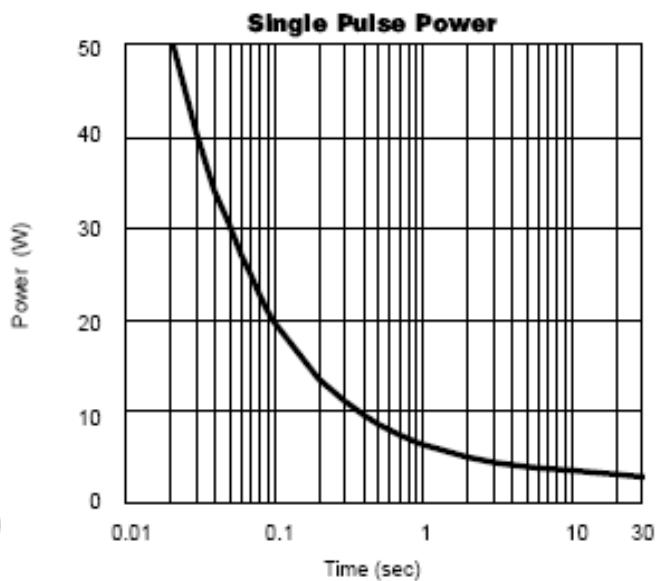
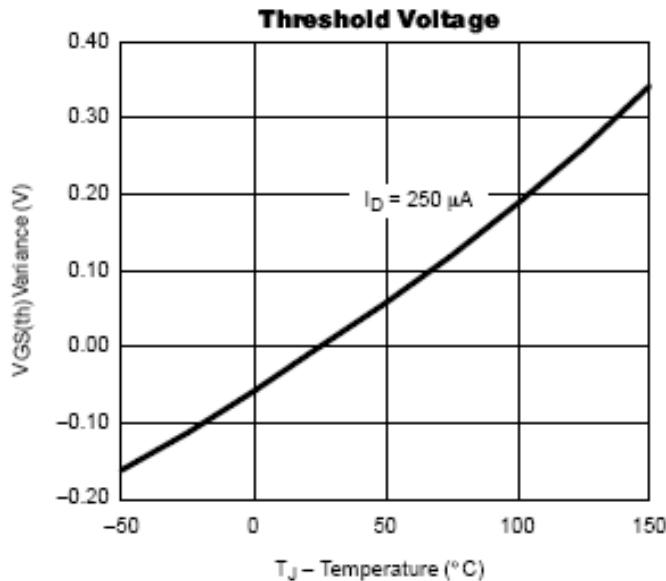




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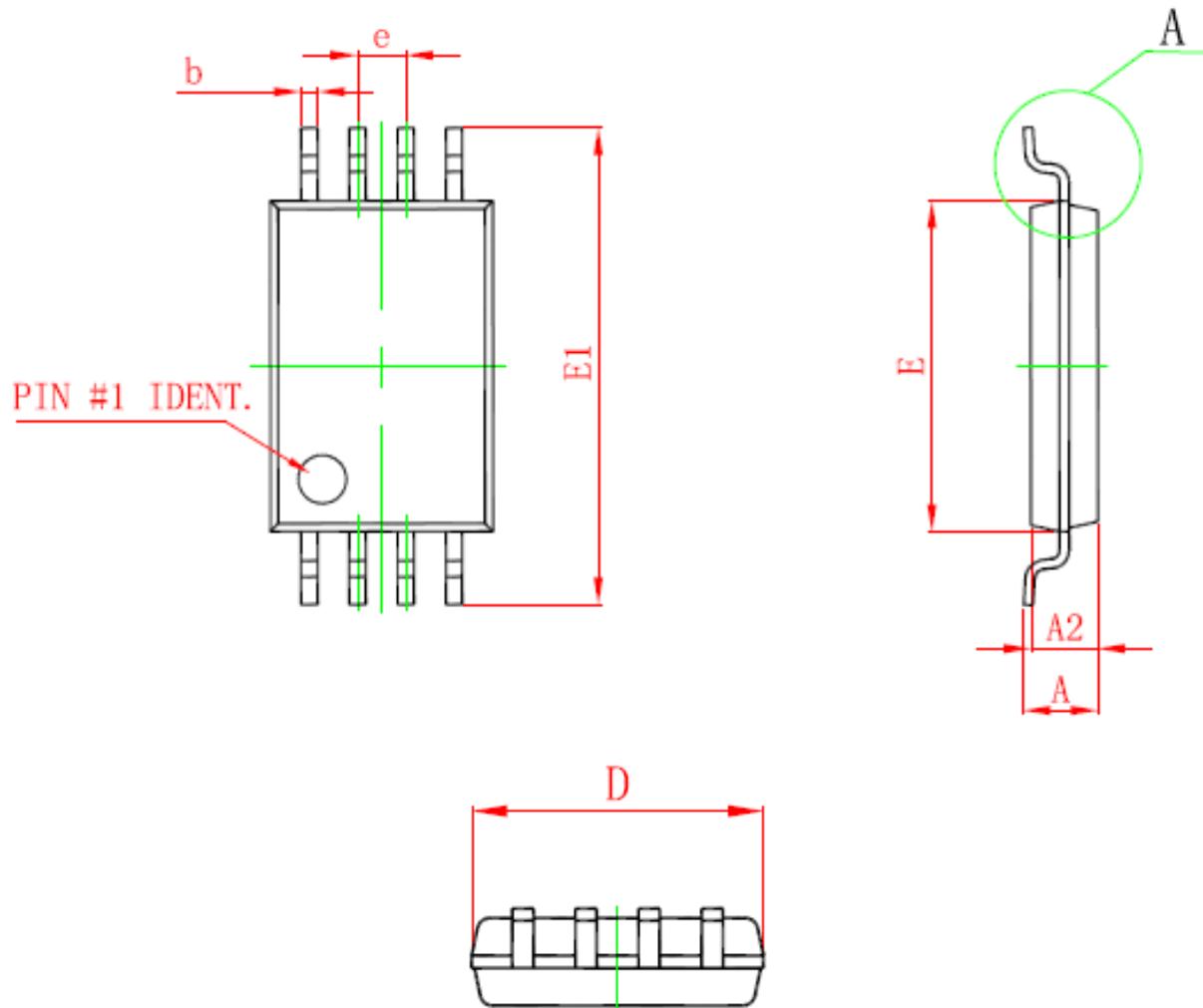




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TSSOP-8P PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
D	2.900	3.100	0.114	0.122
E	4.300	4.500	0.169	0.177
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
E1	6.250	6.550	0.246	0.258
A		1.100		0.043
A2	0.800	1.000	0.031	0.039
A1	0.020	0.150	0.001	0.006
e	0.65 (BSC)		0.026 (BSC)	
L	0.500	0.700	0.020	0.028
H	0.25 (TYP)		0.01 (TYP)	
θ	1°	7°	1°	7°



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